

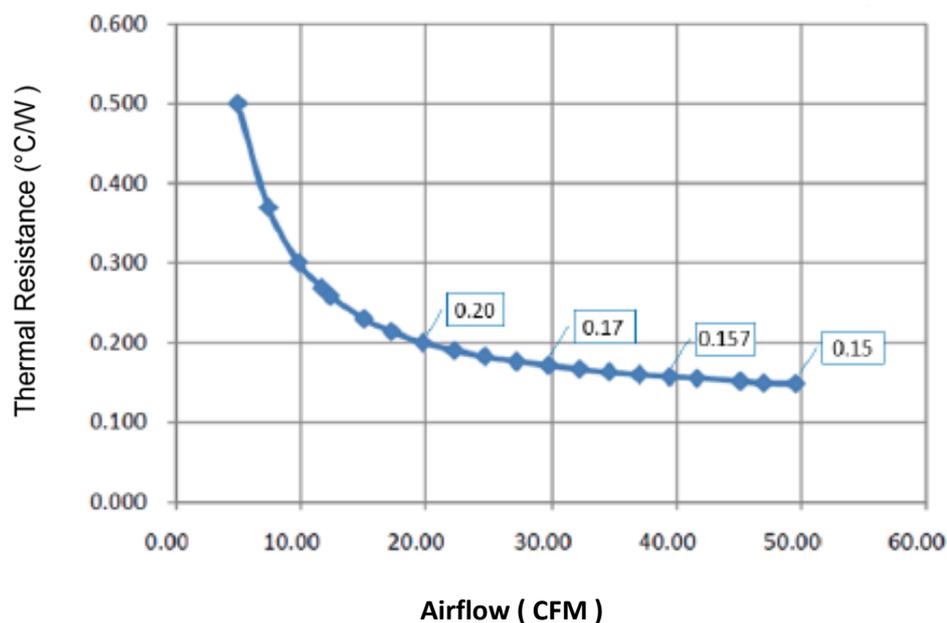
Application :

- Recommend for Intel® Xeon® Platinum / Gold Family Processor (Products formerly Skylake), Socket FCLGA3647
- **For Narrow ILM Only**
- Passive Cooler for 2U Server and up

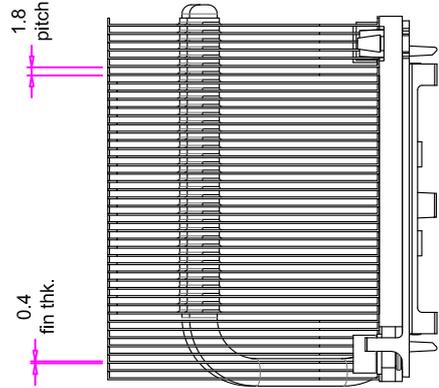
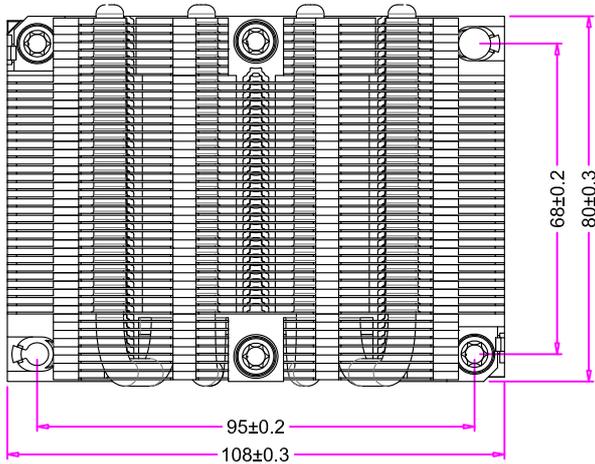
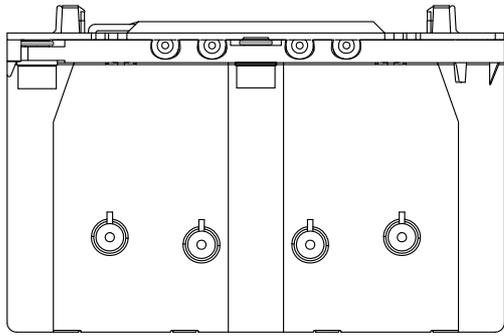
Overall Specification :

- Dimension: 108 x 80 x 64 mm
- Weight: 600 g
- Material : Copper1100 Base, Aluminum Stacked Fin wit Heatpipe Embedded
- Convenient Heat Sink Screw captive mounting
- Thermal Grease Shin-Etsu 7762 Pre-printed
- Support CPU power up to 205 Watts heat dissipation
- Includes both Fabric and Non-Fabric Package Carriers

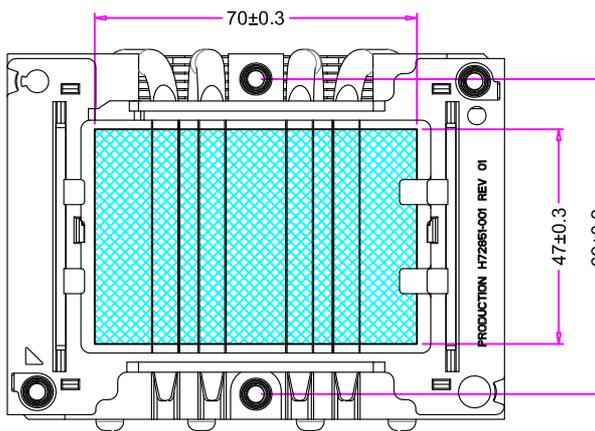
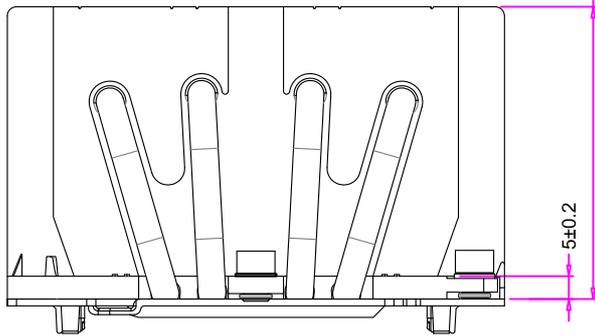
Passive Cooler B8 Thermal Performance Curve :



REV#	DESCRIPTION	CHECKER	DATE
0.0	INITIAL RELEASE	LANG	01/13/17



64±0.3
Heatsink Overall Height



	NAME	DATE
DRAWN BY	enr	01/13/2017
CHECKED BY	LANG	01/13/2017
ENG. APPROVED		
MFG. APPROVED	-	-



DYNATRON CORPORATION

TOP MOTOR

TITLE: 2U Passive Cooler **B8**
Overall Dimension Drawing

CONFIDENTIAL DOCUMENT

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